# SKM400GB12E4



### **IGBT4** Modules

#### SKM400GB12E4

### **Features**

- IGBT4 = 4. generation medium fast trench IGBT (Infineon)
- CAL4 = Soft switching 4. generation CAL-diode
- Isolated copper baseplate using DBC technology (Direct Bonded Copper)
- Increased power cycling capability
- With integrated gate resistor
- For higher switching frequenzies up to 12kHz
- UL recognized, file no. E63532

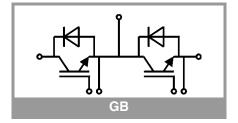
## **Typical Applications\***

- AC inverter drives
- UPS

#### **Remarks**

- Case temperature limited to T<sub>c</sub> = 125°C max.
- Recommended  $T_{op} = -40 \dots +150^{\circ}C$
- Product reliability results valid for T<sub>i</sub> = 150°C

Characteristics						
Symbol	Conditions		min.	typ.	max.	Unit
Inverse diode						
$V_F = V_{EC}$	I <sub>F</sub> = 400 A	T <sub>j</sub> = 25 °C		2.20	2.52	٧
	V <sub>GE</sub> = 0 V chiplevel	T <sub>j</sub> = 150 °C		2.15	2.47	V
V <sub>F0</sub>	chiplevel	T <sub>j</sub> = 25 °C		1.3	1.5	V
		T <sub>j</sub> = 150 °C		0.9	1.1	V
r <sub>F</sub>	chiplevel	T <sub>j</sub> = 25 °C		2.3	2.5	mΩ
		T <sub>j</sub> = 150 °C		3.1	3.4	mΩ
I <sub>RRM</sub>	$I_F = 400 \text{ A}$ $di/dt_{off} = 8800 \text{ A/}\mu\text{s}$ $V_{GE} = \pm 15 \text{ V}$ $V_{CC} = 600 \text{ V}$	T <sub>j</sub> = 150 °C		450		Α
Q <sub>rr</sub>		T <sub>j</sub> = 150 °C		68		μC
E <sub>rr</sub>		T <sub>j</sub> = 150 °C		30.5		mJ
R <sub>th(j-c)</sub>	per diode				0.14	K/W
Module						
L <sub>CE</sub>				15	20	nΗ
R <sub>CC'+EE'</sub>	terminal-chip	T <sub>C</sub> = 25 °C		0.25		mΩ
		T <sub>C</sub> = 125 °C		0.5		mΩ
R <sub>th(c-s)</sub>	per module			0.02	0.038	K/W
Ms	to heat sink M6		3		5	Nm
Mt		to terminals M6	2.5		5	Nm
						Nm
w					325	g



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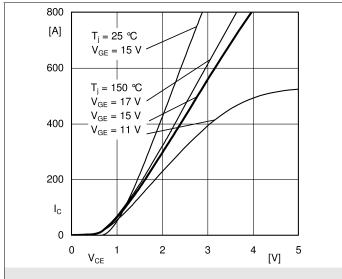


Fig. 1: Typ. output characteristic, inclusive R<sub>CC'+ EE'</sub>

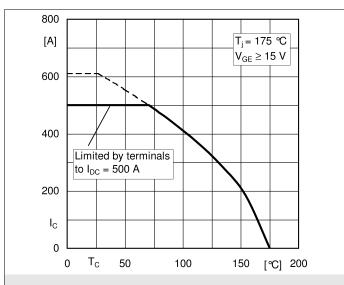


Fig. 2: Rated current vs. temperature  $I_C = f(T_C)$ 

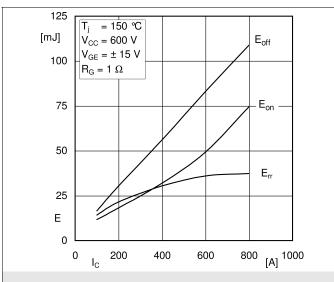


Fig. 3: Typ. turn-on /-off energy =  $f(I_C)$ 

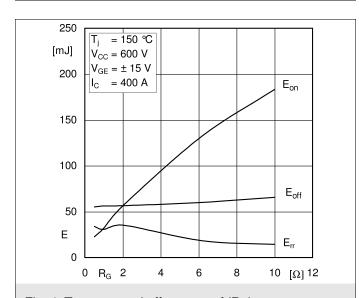
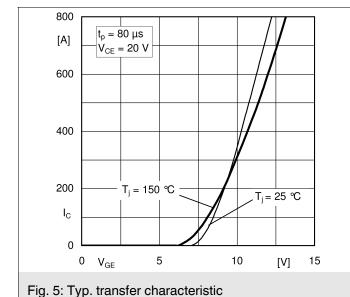
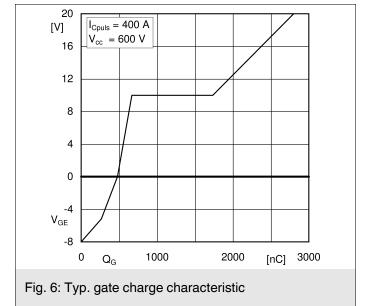
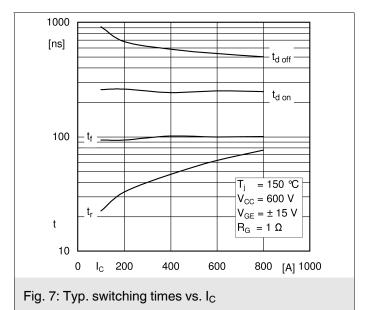


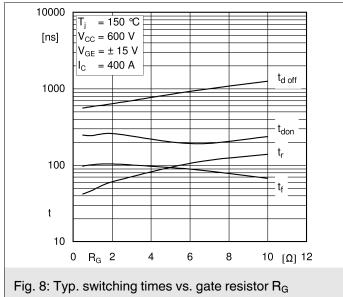
Fig. 4: Typ. turn-on /-off energy =  $f(R_G)$ 

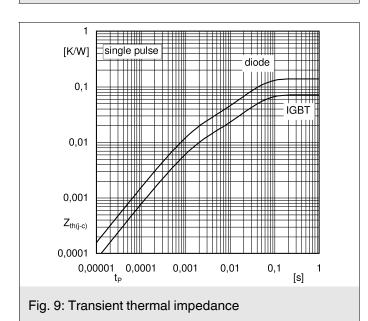


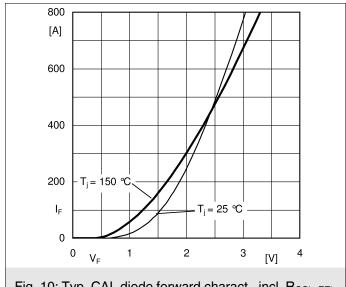


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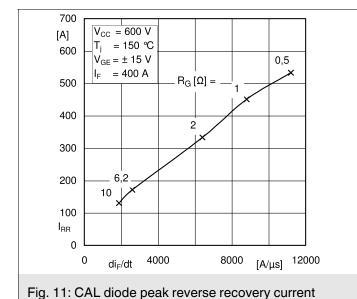


Fig. 10: Typ. CAL diode forward charact., incl. R<sub>CC'+ EE'</sub>

 $R_G[\Omega] =$ 

0,5 - 800

200

100  $= I_F[A]$ 

600

400

12000 [A/µs]



8000

120

100

80

60

40

20  $Q_{rr}$ 

0

[μC]

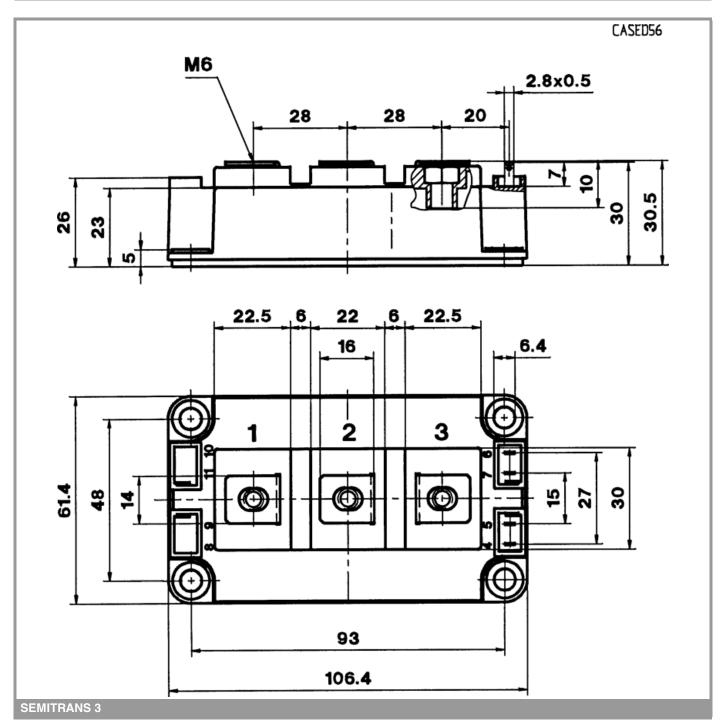
V<sub>CC</sub> = 600 V

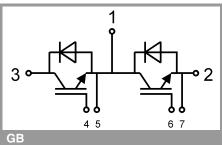
 $V_{GE} = \pm 15 \text{ V}$ 

6,2

= 150 °C

di<sub>F</sub>/dt 4000





This is an electrostatic discharge sensitive device (ESDS), international standard IEC 60747-1, Chapter IX

\* The specifications of our components may not be considered as an assurance of component characteristics. Components have to be tested for the respective application. Adjustments may be necessary. The use of SEMIKRON products in life support appliances and systems is subject to prior specification and written approval by SEMIKRON. We therefore strongly recommend prior consultation of our staff.